

**FEATURES**

**Low Insertion Loss and On Resistance: 2.2  $\Omega$  Typical**

**On Resistance Flatness 0.5  $\Omega$  Typical**

**Automotive Temperature Range**

**-40°C to +125°C**

**-3 dB Bandwidth = 240 MHz**

**Single 3 V/5 V Supply Operation**

**Rail-to-Rail Operation**

**Very Low Distortion: 0.5%**

**Low Quiescent Supply Current (1 nA Typical)**

**Fast Switching Times**

**$t_{ON}$  7 ns**

**$t_{OFF}$  4 ns**

**TTL/CMOS Compatible**

**APPLICATIONS**

**USB 1.1 Signal Switching Circuits**

**Cell Phones**

**PDAs**

**Battery-Powered Systems**

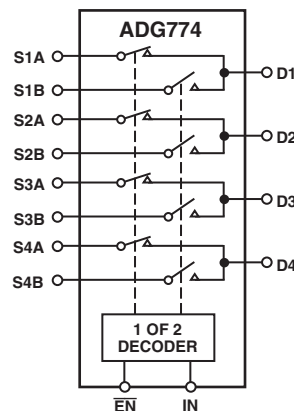
**Communications Systems**

**Data Acquisition Systems**

**Token Ring 4 Mbps/16 Mbps**

**Audio and Video Switching**

**Relay Replacement**

**FUNCTIONAL BLOCK DIAGRAM**

**GENERAL DESCRIPTION**

The ADG774 is a monolithic CMOS device comprising four 2:1 multiplexer/demultiplexers with high impedance outputs. The CMOS process provides low power dissipation yet gives high switching speed and low on resistance. The on resistance variation is typically less than 0.5  $\Omega$  with an input signal ranging from 0 V to 5 V.

The bandwidth of the ADG774 is greater than 200 MHz; this, coupled with low distortion (typically 0.5%), makes the part suitable for switching USB 1.1 data signals and fast Ethernet signals.

The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. Fast switching speed, coupled with high signal bandwidth, also makes the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation, making the parts ideally suited for portable and battery-powered instruments.

The ADG774 operates from a single 3.3 V/5 V supply and is TTL logic compatible. The control logic for each switch is shown in the Truth Table.

These switches conduct equally well in both directions when ON, and have an input signal range that extends to the supplies. In the OFF condition, signal levels up to the supplies are blocked. The ADG774 switches exhibit break-before-make switching action.

**PRODUCT HIGHLIGHTS**

1. Wide -3 dB Bandwidth, 240 MHz.
2. Ultralow Power Dissipation.
3. Extended Signal Range.  
The ADG774 is fabricated on a CMOS process giving an increased signal range that fully extends to the supply rails.
4. Low Leakage Over Temperature.
5. Break-Before-Make Switching.  
This prevents channel shorting when the switches are configured as a multiplexer.
6. Crosstalk Typically -70 dB @ 30 MHz.
7. Off Isolation Typically -60 dB @ 10 MHz.

**REV. C**

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# ADG774—SPECIFICATIONS

**SINGLE SUPPLY** ( $V_{DD} = 5\text{ V} \pm 10\%$ ,  $GND = 0\text{ V}$ . All specifications  $T_{MIN}$  to  $T_{MAX}$  unless otherwise noted.)

| Parameter                                                | B Version <sup>1</sup> |                |                        | Unit             | Test Conditions/Comments                                                                                   |
|----------------------------------------------------------|------------------------|----------------|------------------------|------------------|------------------------------------------------------------------------------------------------------------|
|                                                          | +25°C                  | –40°C to +85°C | –40°C to +125°C        |                  |                                                                                                            |
| ANALOG SWITCH                                            |                        |                |                        |                  |                                                                                                            |
| Analog Signal Range                                      |                        |                | 0 V to V <sub>DD</sub> | V                |                                                                                                            |
| On Resistance (R <sub>ON</sub> )                         | 2.2                    | 5              | 7                      | Ω typ<br>Ω max   | V <sub>D</sub> = 0 V to V <sub>DD</sub> , I <sub>S</sub> = –10 mA                                          |
| On Resistance Match between Channels (ΔR <sub>ON</sub> ) | 0.15                   | 0.5            | 0.5                    | Ω typ<br>Ω max   | V <sub>D</sub> = 0 V to V <sub>DD</sub> , I <sub>S</sub> = –10 mA                                          |
| On Resistance Flatness (R <sub>FLAT(ON)</sub> )          | 0.5                    | 1              | 1                      | Ω typ<br>Ω max   | V <sub>D</sub> = 0 V to V <sub>DD</sub> , I <sub>S</sub> = –1 mA                                           |
| LEAKAGE CURRENTS                                         |                        |                |                        |                  |                                                                                                            |
| Source OFF Leakage I <sub>S</sub> (OFF)                  | ±0.01<br>±0.5          | ±1             | ±1.5                   | nA typ<br>nA max | V <sub>D</sub> = 4.5 V, V <sub>S</sub> = 1 V; V <sub>D</sub> = 1 V, V <sub>S</sub> = 4.5 V; Test Circuit 2 |
| Drain OFF Leakage I <sub>D</sub> (OFF)                   | ±0.01<br>±0.5          | ±1             | ±1.5                   | nA typ<br>nA max | V <sub>D</sub> = 4.5 V, V <sub>S</sub> = 1 V; V <sub>D</sub> = 1 V, V <sub>S</sub> = 4.5 V; Test Circuit 2 |
| Channel ON Leakage I <sub>D</sub> , I <sub>S</sub> (ON)  | ±0.01<br>±0.5          | ±1             | ±1.5                   | nA typ<br>nA max | V <sub>D</sub> = V <sub>S</sub> = 4.5 V; V <sub>D</sub> = V <sub>S</sub> = 1 V; Test Circuit 3             |
| DIGITAL INPUTS                                           |                        |                |                        |                  |                                                                                                            |
| Input High Voltage, V <sub>INH</sub>                     |                        |                | 2.0                    | V min            |                                                                                                            |
| Input Low Voltage, V <sub>INL</sub>                      |                        |                | 0.8                    | V max            |                                                                                                            |
| Input Current<br>I <sub>INL</sub> or I <sub>INH</sub>    | 0.001                  |                | ±0.5                   | μA typ<br>μA max | V <sub>IN</sub> = V <sub>INL</sub> or V <sub>INH</sub>                                                     |
| DYNAMIC CHARACTERISTICS <sup>2</sup>                     |                        |                |                        |                  |                                                                                                            |
| t <sub>ON</sub>                                          | 7<br>15                |                | 20                     | ns typ<br>ns max | R <sub>L</sub> = 100 Ω, C <sub>L</sub> = 35 pF, V <sub>S</sub> = +3 V; Test Circuit 4                      |
| t <sub>OFF</sub>                                         | 4<br>8                 |                | 9                      | ns typ<br>ns max | R <sub>L</sub> = 100 Ω, C <sub>L</sub> = 35 pF, V <sub>S</sub> = +3 V; Test Circuit 4                      |
| Break-Before-Make Time Delay, t <sub>D</sub>             | 5<br>1                 |                |                        | ns typ<br>ns min | R <sub>L</sub> = 100 Ω, C <sub>L</sub> = 35 pF, V <sub>S1</sub> = V <sub>S2</sub> = +5 V; Test Circuit 5   |
| Off Isolation                                            | –65                    |                |                        | dB typ           | R <sub>L</sub> = 100 Ω, f = 10 MHz; Test Circuit 7                                                         |
| Channel-to-Channel Crosstalk                             | –75                    |                |                        | dB typ           | R <sub>L</sub> = 100 Ω, f = 10 MHz; Test Circuit 8                                                         |
| Bandwidth –3 dB                                          | 240                    |                |                        | MHz typ          | R <sub>L</sub> = 100 Ω; Test Circuit 6                                                                     |
| Distortion                                               | 0.5                    |                |                        | % typ            | R <sub>L</sub> = 100 Ω                                                                                     |
| Charge Injection                                         | 10                     |                |                        | pC typ           | C <sub>L</sub> = 1 nF; Test Circuit 9                                                                      |
| C <sub>S</sub> (OFF)                                     | 10                     |                |                        | pF typ           | f = 1 kHz                                                                                                  |
| C <sub>D</sub> (OFF)                                     | 20                     |                |                        | pF typ           | f = 1 kHz                                                                                                  |
| C <sub>D</sub> , C <sub>S</sub> (ON)                     | 30                     |                |                        | pF typ           | f = 1 MHz                                                                                                  |
| POWER REQUIREMENTS                                       |                        |                |                        |                  |                                                                                                            |
| I <sub>DD</sub>                                          | 0.001                  | 1              | 1                      | μA max<br>μA typ | V <sub>DD</sub> = +5.5 V<br>Digital Inputs = 0 V or V <sub>DD</sub>                                        |
| I <sub>IN</sub>                                          |                        | 1              | 1                      | μA typ           | V <sub>IN</sub> = +5 V                                                                                     |
| I <sub>O</sub>                                           |                        | 100            |                        | mA max           | V <sub>S</sub> /V <sub>D</sub> = 0 V                                                                       |

## NOTES

<sup>1</sup>Temperature range: B Version, –40°C to +125°C.

<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

# SINGLE SUPPLY (V<sub>DD</sub> = 3 V ± 10%, GND = 0 V. All specifications T<sub>MIN</sub> to T<sub>MAX</sub> unless otherwise noted.)

| Parameter                                                | B Version <sup>1</sup> |       |                        | Unit    | Test Conditions/Comments                                                                                |
|----------------------------------------------------------|------------------------|-------|------------------------|---------|---------------------------------------------------------------------------------------------------------|
|                                                          | +25°C                  | +85°C | +125°C                 |         |                                                                                                         |
| ANALOG SWITCH                                            |                        |       |                        |         |                                                                                                         |
| Analog Signal Range                                      | 4                      |       | 0 V to V <sub>DD</sub> | V       | V <sub>D</sub> = 0 V to V <sub>DD</sub> , I <sub>S</sub> = –10 mA                                       |
| On Resistance (R <sub>ON</sub> )                         |                        |       |                        | Ω typ   |                                                                                                         |
|                                                          |                        | 8     | 9                      | Ω max   |                                                                                                         |
| On Resistance Match between Channels (ΔR <sub>ON</sub> ) | 0.15                   |       |                        | Ω typ   | V <sub>D</sub> = 0 V to V <sub>DD</sub> , I <sub>S</sub> = –10 mA                                       |
|                                                          |                        | 0.5   | 0.5                    | Ω max   |                                                                                                         |
| On Resistance Flatness (R <sub>FLAT(ON)</sub> )          | 2                      |       |                        | Ω typ   |                                                                                                         |
|                                                          |                        | 4     | 4                      | Ω max   | V <sub>D</sub> = 0 V to V <sub>DD</sub> , I <sub>S</sub> = –10 mA                                       |
| LEAKAGE CURRENTS                                         |                        |       |                        |         |                                                                                                         |
| Source OFF Leakage I <sub>S</sub> (OFF)                  | ±0.01                  |       |                        | nA typ  | V <sub>D</sub> = 3 V, V <sub>S</sub> = 1 V; V <sub>D</sub> = 1 V, V <sub>S</sub> = 3 V; Test Circuit 2  |
|                                                          | ±0.5                   | ±1    | ±1.5                   | nA max  |                                                                                                         |
| Drain OFF Leakage I <sub>D</sub> (OFF)                   | ±0.01                  |       |                        | nA typ  | V <sub>D</sub> = 3 V, V <sub>S</sub> = 1 V; V <sub>D</sub> = 1 V, V <sub>S</sub> = 3 V; Test Circuit 2  |
|                                                          | ±0.5                   | ±1    | ±1.5                   | nA max  |                                                                                                         |
| Channel ON Leakage I <sub>D</sub> , I <sub>S</sub> (ON)  | ±0.01                  |       |                        | nA typ  | V <sub>D</sub> = V <sub>S</sub> = 3 V; V <sub>D</sub> = V <sub>S</sub> = 1 V; Test Circuit 3            |
|                                                          | ±0.5                   | ±1    | ±1.5                   | nA max  |                                                                                                         |
| DIGITAL INPUTS                                           |                        |       |                        |         |                                                                                                         |
| Input High Voltage, V <sub>INH</sub>                     |                        |       | 2.0                    | V min   | V <sub>IN</sub> = V <sub>INL</sub> or V <sub>INH</sub>                                                  |
| Input Low Voltage, V <sub>INL</sub>                      |                        |       | 0.8                    | V max   |                                                                                                         |
| Input Current                                            | 0.001                  |       |                        |         |                                                                                                         |
| I <sub>INL</sub> or I <sub>INH</sub>                     |                        |       |                        | μA typ  |                                                                                                         |
|                                                          |                        |       | ±0.5                   | μA max  |                                                                                                         |
| DYNAMIC CHARACTERISTICS <sup>2</sup>                     |                        |       |                        |         |                                                                                                         |
| t <sub>ON</sub>                                          | 8                      |       |                        | ns typ  | R <sub>L</sub> = 100 Ω, C <sub>L</sub> = 35 pF, V <sub>S</sub> = +1.5 V; Test Circuit 4                 |
|                                                          | 16                     | 21    |                        | ns max  |                                                                                                         |
| t <sub>OFF</sub>                                         | 5                      |       |                        | ns typ  | R <sub>L</sub> = 100 Ω, C <sub>L</sub> = 35 pF, V <sub>S</sub> = +1.5 V; Test Circuit 4                 |
|                                                          | 10                     | 11    |                        | ns max  |                                                                                                         |
| Break-Before-Make Time Delay, t <sub>D</sub>             | 5                      |       |                        | ns typ  | R <sub>L</sub> = 100 Ω, C <sub>L</sub> = 35 pF, V <sub>S1</sub> = V <sub>S2</sub> = 3 V; Test Circuit 5 |
|                                                          | 1                      |       |                        | ns min  |                                                                                                         |
| Off Isolation                                            | –65                    |       |                        | dB typ  | R <sub>L</sub> = 50 Ω, f = 10 MHz; Test Circuit 7                                                       |
| Channel-to-Channel Crosstalk                             | –75                    |       |                        | dB typ  |                                                                                                         |
| Bandwidth –3 dB                                          | 240                    |       |                        | MHz typ | R <sub>L</sub> = 50 Ω; Test Circuit 6                                                                   |
| Distortion                                               | 2                      |       |                        | % typ   | R <sub>L</sub> = 50 Ω                                                                                   |
| Charge Injection                                         | 3                      |       |                        | pC typ  | C <sub>L</sub> = 1 nF; Test Circuit 9                                                                   |
| C <sub>S</sub> (OFF)                                     | 10                     |       |                        | pF typ  | f = 1 kHz                                                                                               |
| C <sub>D</sub> (OFF)                                     | 20                     |       |                        | pF typ  | f = 1 kHz                                                                                               |
| C <sub>D</sub> , C <sub>S</sub> (ON)                     | 30                     |       |                        | pF typ  | f = 1 MHz                                                                                               |
| POWER REQUIREMENTS                                       |                        |       |                        |         |                                                                                                         |
| I <sub>DD</sub>                                          | 0.001                  | 1     | 1                      | μA max  | V <sub>DD</sub> = +3.3 V<br>Digital Inputs = 0 V or V <sub>DD</sub>                                     |
|                                                          |                        |       |                        | μA typ  |                                                                                                         |
| I <sub>IN</sub>                                          |                        | 1     | 1                      | μA typ  |                                                                                                         |
| I <sub>O</sub>                                           |                        | 100   |                        | mA max  | V <sub>IN</sub> = +3 V<br>V <sub>S</sub> /V <sub>D</sub> = 0 V                                          |

## NOTES

<sup>1</sup>Temperature range: B Version, –40°C to +125°C.<sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

Table I. Truth Table

| $\overline{\text{EN}}$ | IN | D1   | D2   | D3   | D4   | Function |
|------------------------|----|------|------|------|------|----------|
| 1                      | X  | Hi-Z | Hi-Z | Hi-Z | Hi-Z | DISABLE  |
| 0                      | 0  | S1A  | S2A  | S3A  | S4A  | IN = 0   |
| 0                      | 1  | S1B  | S2B  | S3B  | S4B  | IN = 1   |

# ADG774

## ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

(T<sub>A</sub> = 25°C unless otherwise noted.)

|                                     |                                                                       |
|-------------------------------------|-----------------------------------------------------------------------|
| V <sub>DD</sub> to GND              | −0.3 V to +6 V                                                        |
| Analog, Digital Inputs <sup>2</sup> | −0.3 V to V <sub>DD</sub> + 0.3 V or<br>30 mA, Whichever Occurs First |
| Continuous Current, S or D          | 100 mA                                                                |
| Peak Current, S or D                | 300 mA<br>(Pulsed at 1 ms, 10% Duty Cycle max)                        |
| Operating Temperature Range         |                                                                       |
| Industrial (B Version)              | −40°C to +125°C                                                       |
| Storage Temperature Range           | −65°C to +150°C                                                       |
| Junction Temperature                | 150°C                                                                 |
| SOIC Package, Power Dissipation     | 600 mW                                                                |
| θ <sub>JA</sub> Thermal Impedance   | 100°C/W                                                               |

|                                        |            |
|----------------------------------------|------------|
| QSOP Package, Power Dissipation        | 566 mW     |
| θ <sub>JA</sub> Thermal Impedance      | 149.97°C/W |
| Lead Temperature, Soldering (10 sec)   | 300°C      |
| I R Reflow, Peak Temperature (<20 sec) | 235°C      |
| ESD                                    | 2 kV       |

## NOTES

<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

<sup>2</sup>Overvoltages at IN, S, or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

## ORDERING GUIDE

| Model             | Temperature Range | Package Descriptions                  | Package Options |
|-------------------|-------------------|---------------------------------------|-----------------|
| ADG774BR          | −40°C to +125°C   | Standard Small Outline Package (SOIC) | R-16            |
| ADG774BR-REEL     | −40°C to +125°C   | Standard Small Outline Package (SOIC) | R-16            |
| ADG774BR-REEL7    | −40°C to +125°C   | Standard Small Outline Package (SOIC) | R-16            |
| ADG774BRZ*        | −40°C to +125°C   | Standard Small Outline Package (SOIC) | R-16            |
| ADG774BRZ-REEL*   | −40°C to +125°C   | Standard Small Outline Package (SOIC) | R-16            |
| ADG774BRZ-REEL7*  | −40°C to +125°C   | Standard Small Outline Package (SOIC) | R-16            |
| ADG774BRQ         | −40°C to +125°C   | Shrink Small Outline Package (QSOP)   | RQ-16           |
| ADG774BRQ-REEL    | −40°C to +125°C   | Shrink Small Outline Package (QSOP)   | RQ-16           |
| ADG774BRQ-REEL7   | −40°C to +125°C   | Shrink Small Outline Package (QSOP)   | RQ-16           |
| ADG774BRQZ*       | −40°C to +125°C   | Shrink Small Outline Package (QSOP)   | RQ-16           |
| ADG774BRQZ-REEL*  | −40°C to +125°C   | Shrink Small Outline Package (QSOP)   | RQ-16           |
| ADG774BRQZ-REEL7* | −40°C to +125°C   | Shrink Small Outline Package (QSOP)   | RQ-16           |

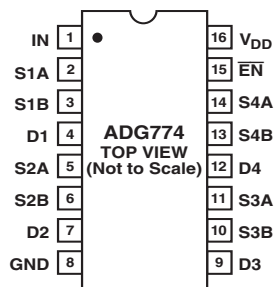
\*Z = Pb-free part.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG774 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



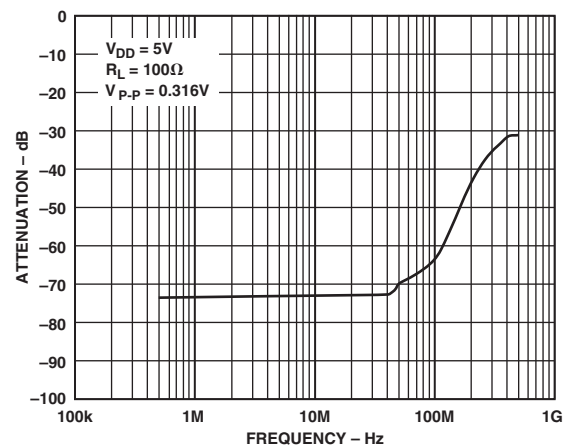
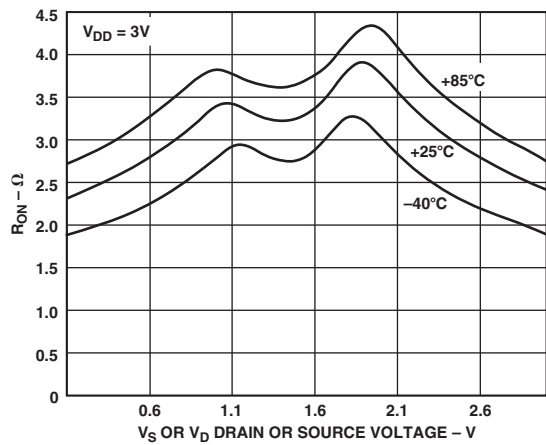
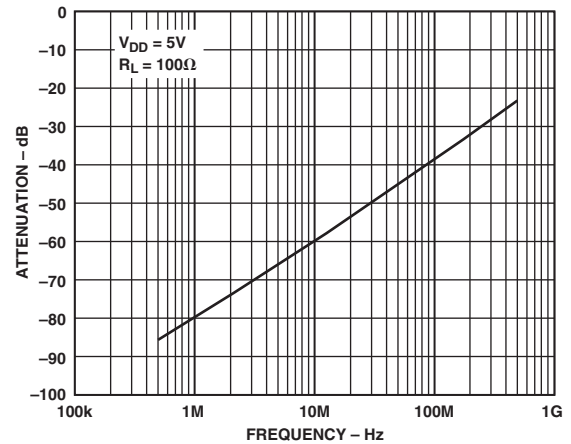
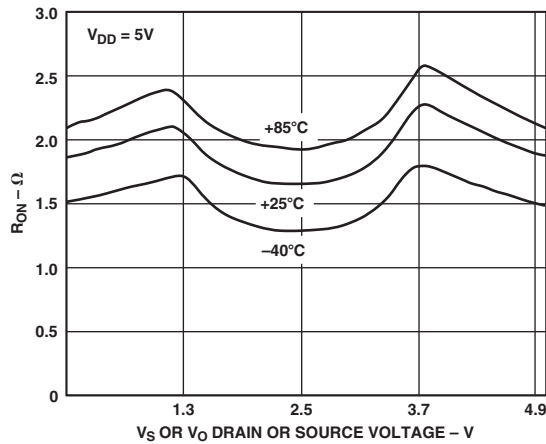
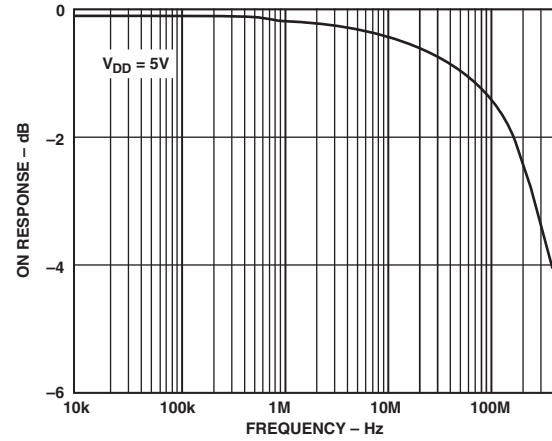
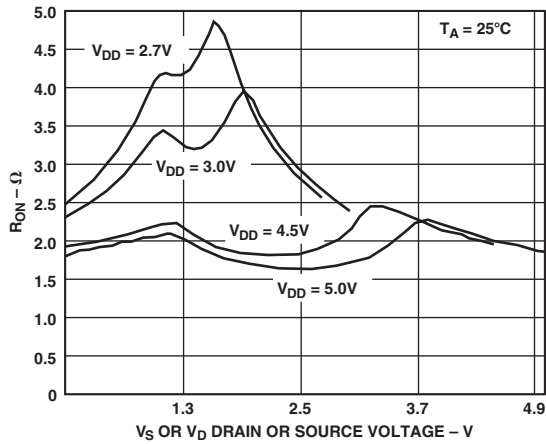
### PIN CONFIGURATION (SOIC/QSOP)

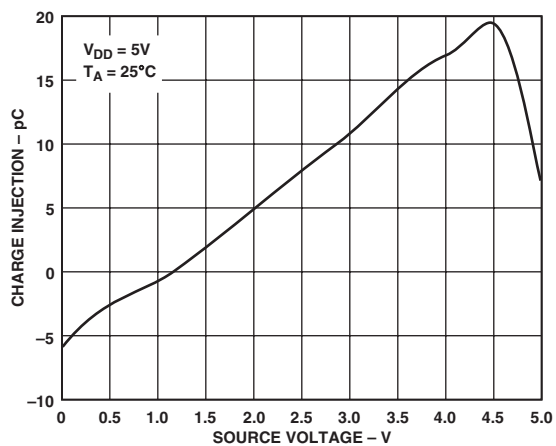


### TERMINOLOGY

|                 |                                                                                                                                                  |
|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| $V_{DD}$        | Most Positive Power Supply Potential.                                                                                                            |
| GND             | Ground (0 V) Reference.                                                                                                                          |
| S               | Source Terminal. May be an input or output.                                                                                                      |
| D               | Drain Terminal. May be an input or output.                                                                                                       |
| IN              | Logic Control Input.                                                                                                                             |
| $\overline{EN}$ | Logic Control Input.                                                                                                                             |
| $R_{ON}$        | Ohmic Resistance between D and S.                                                                                                                |
| $\Delta R_{ON}$ | On Resistance Match between any Two Channels, i.e., $R_{ON\ max} - R_{ON\ min}$ .                                                                |
| $R_{FLAT(ON)}$  | Flatness is defined as the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range. |
| $I_S$ (OFF)     | Source Leakage Current with the Switch OFF.                                                                                                      |
| $I_D$ (OFF)     | Drain Leakage Current with the Switch OFF.                                                                                                       |
| $I_D, I_S$ (ON) | Channel Leakage Current with the Switch ON.                                                                                                      |
| $V_D$ ( $V_S$ ) | Analog Voltage on Terminals D, S.                                                                                                                |
| $C_S$ (OFF)     | OFF Switch Source Capacitance.                                                                                                                   |
| $C_D$ (OFF)     | OFF Switch Drain Capacitance.                                                                                                                    |
| $C_D, C_S$ (ON) | ON Switch Capacitance.                                                                                                                           |
| $t_{ON}$        | Delay between Applying the Digital Control Input and the Output Switching on. See Test Circuit 4.                                                |
| $t_{OFF}$       | Delay between Applying the Digital Control Input and the Output Switching Off.                                                                   |
| $t_D$           | OFF Time or ON Time Measured between the 90% Points of Both Switches, When Switching from One Address State to Another. See Test Circuit 5.      |
| Crosstalk       | A Measure of Unwanted Signal that is Coupled through from One Channel to Another as a Result of Parasitic Capacitance.                           |
| Off Isolation   | A Measure of Unwanted Signal Coupling through an OFF Switch.                                                                                     |
| Bandwidth       | Frequency Response of the Switch in the ON State Measured at 3 dB Down.                                                                          |
| Distortion      | $R_{FLAT(ON)}/R_L$                                                                                                                               |

# ADG774—Typical Performance Characteristics





TPC 7. Charge Injection vs. Source Voltage

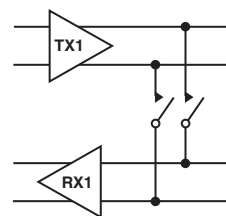


Figure 1. Loop Back

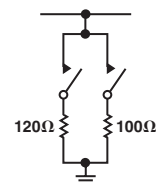


Figure 2. Line Termination

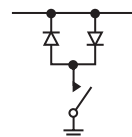
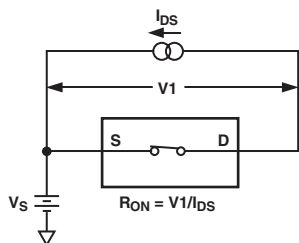


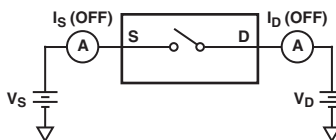
Figure 3. Line Clamp

# ADG774

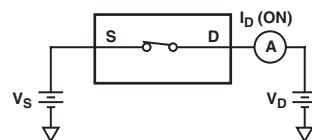
## Test Circuits



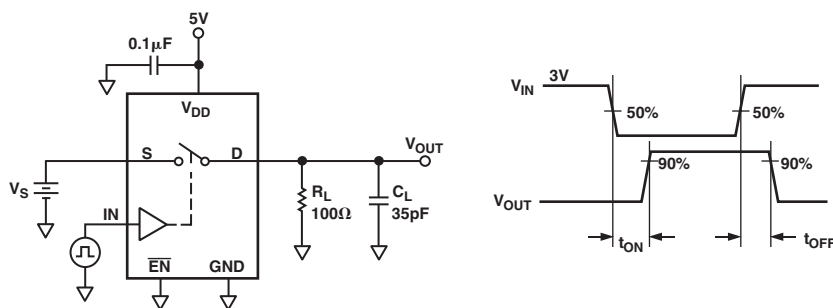
Test Circuit 1. On Resistance



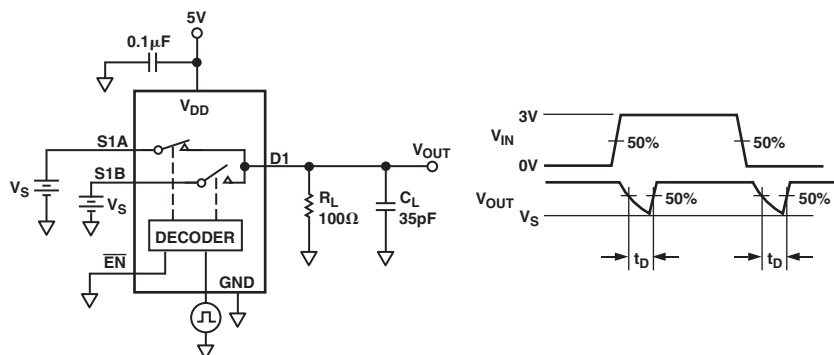
Test Circuit 2. Off Leakage



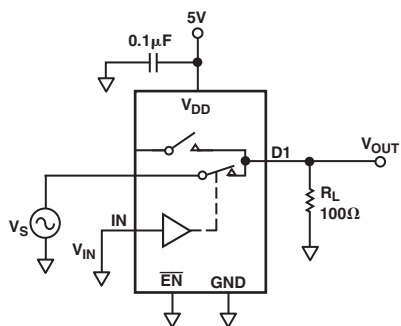
Test Circuit 3. On Leakage



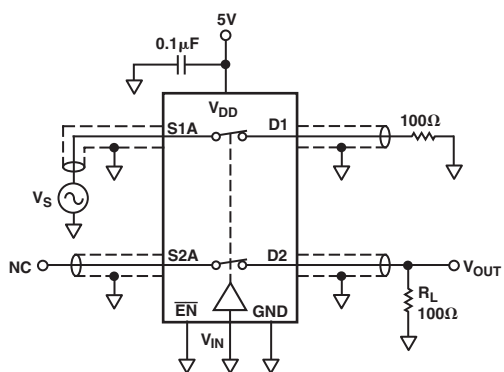
Test Circuit 4. Switching Times



Test Circuit 5. Break-Before-Make Time Delay

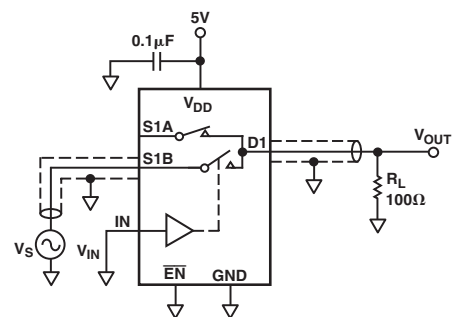


Test Circuit 6. Bandwidth

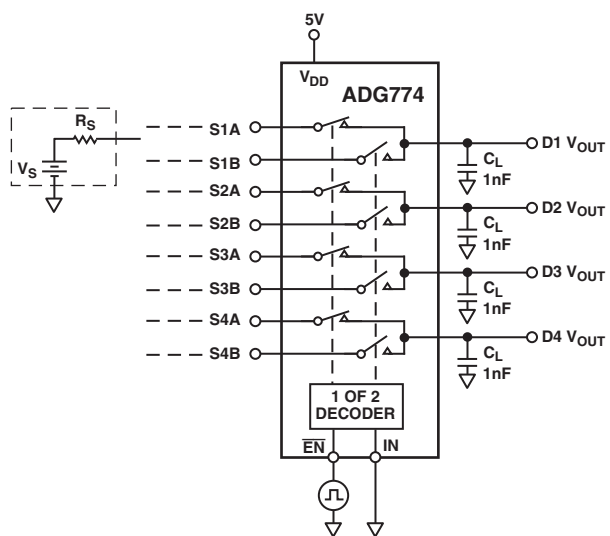


$$\text{CHANNEL-TO-CHANNEL CROSSTALK} = 20 \times \log |V_S/V_{OUT}|$$

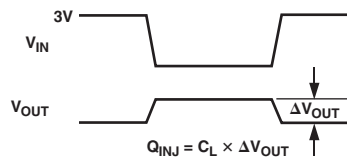
Test Circuit 7. Channel-to-Channel Crosstalk



Test Circuit 8. Off Isolation



Test Circuit 9. Charge Injection

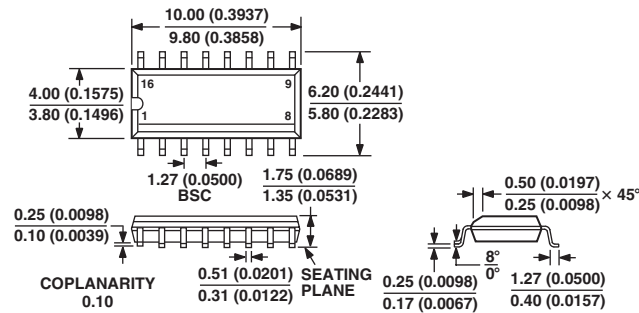


$$Q_{INJ} = C_L \times \Delta V_{OUT}$$

OUTLINE DIMENSIONS

16-Lead Standard Small Outline Package [SOIC]  
Narrow Body  
(R-16)

Dimensions shown in millimeters and (inches)

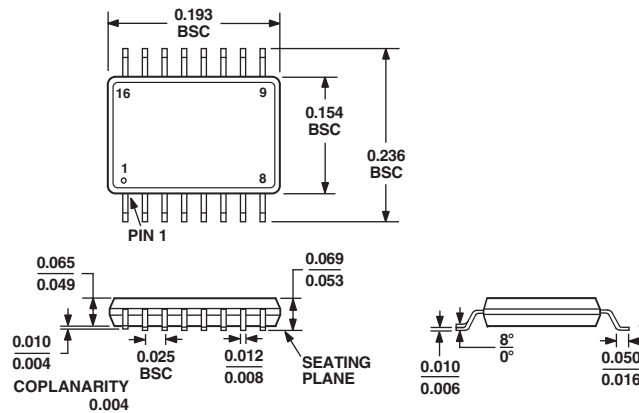


COMPLIANT TO JEDEC STANDARDS MS-012AC

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

16-Lead Shrink Small Outline Package [QSOP]  
(RQ-16)

Dimensions shown in inches



COMPLIANT TO JEDEC STANDARDS MO-137AB

## Revision History

| Location                                               | Page      |
|--------------------------------------------------------|-----------|
| <b>3/04—Data Sheet changed from REV. B to REV. C.</b>  |           |
| Added APPLICATIONS .....                               | 1         |
| Changes to ORDERING GUIDE .....                        | 4         |
| <b>10/03—Data Sheet changed from REV. A to REV. B.</b> |           |
| Updated formatting .....                               | Universal |
| Renumbered TPCs and Figures .....                      | Universal |
| Changes to FEATURES .....                              | 1         |
| Changes to APPLICATIONS .....                          | 1         |
| Changes to PRODUCT HIGHLIGHTS .....                    | 1         |
| Changes to SPECIFICATIONS .....                        | 2         |
| Changes to ABSOLUTE MAXIMUM RATINGS .....              | 4         |
| Updated ORDERING GUIDE .....                           | 4         |
| Delete Figure 2 .....                                  | 7         |
| Updated OUTLINE DIMENSIONS .....                       | 10        |
| <b>4/03—Data Sheet changed from REV. 0 to REV. A.</b>  |           |
| Renumbered TPCs and Figures .....                      | Universal |
| Updated OUTLINE DIMENSIONS .....                       | 8         |



Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А